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# NOMENCLATURE

## Roman Symbols

$A$	heat-transfer area, $\text{m}^2$ Chapters 3, 5
$A_f$	fin area, $\text{m}^2$ , Chapter 3
$C$	capacitance, $\text{F}$ , Chapter 1
$C_p$	specific heat at constant pressure, $\text{kJ kg}^{-1} \text{ }^\circ\text{C}^{-1}$ , Chapter 3
$D$	diameter, $\text{m}$ , Chapter 4
$f$	frequency, $\text{Hz}$ , Chapter 1
$g$	acceleration of gravity, $\text{kg m s}^{-2}$ , Chapter 4
$h$	heat-transfer coefficient, $\text{W m}^{-2} \text{K}^{-1}$ , Chapters 3, 5; height, $\text{m}$ , Chapter 3; head, $\text{m}$ , Chapter 4
$\bar{h}$	average heat-transfer coefficient, $\text{W m}^{-2} \text{K}^{-1}$ , Chapter 3
$H$	total head, $\text{m}$ , Chapter 4
$k$	thermal conductivity, $\text{W m}^{-1} \text{K}^{-1}$ , Chapters 1, 3, 5
$K$	degrees Kelvin, Chapter 4
$L$	length, $\text{m}$ , Chapters 3, 5
$m$	parameter used in fin analysis, Chapter 3
$M$	parameter used in fin analysis, Chapter 3
$\dot{m}$	mass flow rate, $\text{kg s}^{-1}$ , Chapter 3
$n$	rotational speed, revolutions $\text{min}^{-1}$ , Chapter 4
$p$	pressure, $\text{kPa}$ , Chapter 4
$p_o$	total pressure, $\text{kPa}$ , Chapter 4
$P$	power, $\text{W}$ , Chapters 1, 3, 4; perimeter, $\text{m}$ , Chapter 3
$PUE$	power usage effectiveness, Chapter 6
$q$	power, $\text{W}$ , Chapters 1, 3, 5
$q''$	heat flux, $\text{W cm}^{-2}$ , Chapter 3
$Q$	volumetric flow rate, $\text{m}^3 \text{ s}^{-1}$ , Chapter 4
$R$	thermal resistance per unit area or insulance, $\text{cm}^2 \text{ }^\circ\text{C W}^{-1}$ , Chapter 3
$t$	thickness, $\text{m}$ , Chapter 3
$T$	temperature, ${}^\circ\text{C}$ , Chapters 1, 3, 5
$U$	thermal conductance, $\text{W } {}^\circ\text{C}^{-1}$ , Chapter 3
$v$	velocity, $\text{m s}^{-1}$ , Chapter 4
$V$	volts, $\text{V}$ , Chapter 1
$w$	width, $\text{m}$ , Chapter 3
$x$	distance, $\text{m}$ , Chapter 3
$z$	height, $\text{m}$ , Chapter 4

## Greek Symbols

$\nabla$	dell operator, Chapter 3
$\Delta T$	delta temperature, ${}^\circ\text{C}$ , Chapters 3, 5

$\varepsilon$	fin effectiveness, Chapter 3
$\eta$	fin efficiency, Chapters 3, 4
$\theta$	thermal resistance, $^{\circ}\text{C W}^{-1}$ , Chapters 3, 5
$\Pi$	nondimensional parameter, Chapter 4
$\rho$	density, $\text{kg m}^{-3}$ , Chapter 4

### Subscripts

1	first, Chapters 1, 3
2	second, Chapters 1, 3
<i>AMB</i>	ambient, Chapter 3
<i>b</i>	base, Chapter 3
<i>BGA</i>	Chapter 3
<i>Board</i>	Chapter 3
<i>BottomPath</i>	Chapter 3
<i>c</i>	corrected length, m, Chapter 3
<i>C</i>	case, Chapter 3
<i>Carrier</i>	Chapter 3
<i>Case</i>	Chapter 3
<i>Conductive</i>	Chapter 5
<i>Convective</i>	Chapter 5
<i>dynamic</i>	Chapter 4
<i>f</i>	fin, Chapter 3
<i>head</i>	Chapter 4
<i>inlet</i>	Chapter 3
<i>J</i>	junction, Chapter 3
<i>JA</i>	junction to air, Chapter 3
<i>JB</i>	junction to base, Chapter 3
<i>JC</i>	junction to case, Chapter 3
<i>JS</i>	junction to heat sink, Chapter 3
<i>Junction</i>	Chapter 3
<i>max</i>	Chapter 3
<i>outlet</i>	Chapter 3
<i>TIM1</i>	Chapter 3
<i>TIM2</i>	Chapter 3
<i>TopPath</i>	Chapter 3
<i>s</i>	surface, Chapter 3
<i>SA</i>	sink to air, Chapter 3
<i>Substrate</i>	Chapter 3
<i>SurfaceA</i>	Chapter 3
<i>SurfaceB</i>	Chapter 3
$\infty$	infinity, Chapter 3

### Superscripts

"	flux, Chapter 3
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